Specifications for Approval

Customer Part No.:

	Inhere Part No.	: LYG935A3-001					
	Part Name: 平头小蝴蝶水清透明黄绿光 LED						
	Spec Issue Date: 2018-08-13						
	Revision No.: A						
	==========						
To Customer:							
		ng information for your approval					
■ Sample			D Dimension				
	■ Electrical Characteristics Curve ■ Internal Circuit Diagram ■ Soldering recommendation						
= 50ldering	, recommendation						
Prepared by:	: Lily	Checked by: Tom	Approved by: Wangxiaojun				
Date: 2018-0)8-13	Date: 2018-08-13	Date: 2018-08-13				
Customer Op	-						
	nd no objection						
☐ Reject with	h the following rea	son:					



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SPECIFICATIONS

Features

- High speed response.
- High reliability and long life.
- Low power consumption.
- Available in red, orange, yellow, yellow-green, green, blue, white, pink*
- Suitable for pulse operation.
- RoHS compliant.

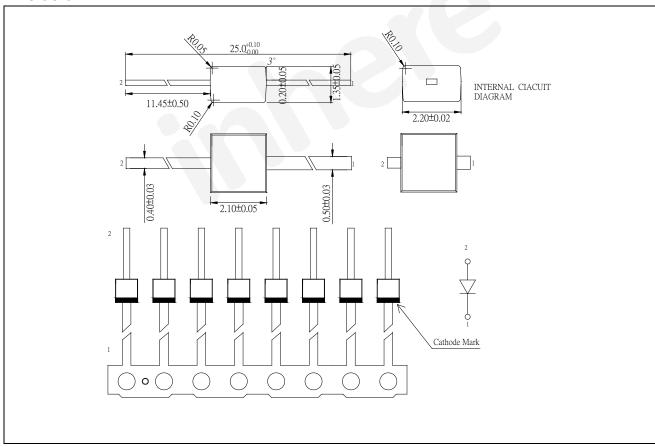
Description

• The Yellow Green source color devices are made with AlGaInP on GaAs Light Emitting Diode.

Applications

- Automotive: Dashboards, stop lamps,
- Backlighting: LCDs, Key pads advertising
- Status indicators: Consumer & industrial electronics.
- General use

Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25 (0.01") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

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Selection Guide

		- ····		I _V (mcd) @ 20mA			Viewing Angle(°)	
Part No.	Dice	Emitting Color	Lens Type	Min.	Тур.	Max	$2\theta_{\frac{1}{2}}$	
LYG935A3-001	AlGaInP	Yellow Green	Water Clear	20	60		120	

Note:

- $1.\, heta_{\frac{1}{2}}$ is the angle from optical centerline where the luminous intensity is $\,\frac{1}{2}\,$ the optical centerline value.
- 2. The tolerance of luminous intensity (Iv) is $\pm 15\%$.

Electrical / Optical Characteristics (at $T_a = 25^{\circ}C$)

Parameter	Symbol	Value					
		Min.	Тур.	Max.	Unit	Test Condition	
Forward Voltage	$V_{\rm F}$	1.8		2.4	V	I _F = 20mA	
Dominant Wavelength	$\lambda_{_{\mathrm{D}}}$	565		575	nm	I _F = 20mA	
Reverse Current	I_R			10	μА	V _R = 5V	
Spectral Line Half Width	Δλ		18	~~~ C	nm	I _F = 20mA	

Note:

- 1.The tolerance of forward voltage is $\pm\,$ 0.05V..
- 2. The tolerance of dominant wavelength is ± 1 nm.
- 3. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

Absolute Maximum Ratings (at $T_a = 25$ °C)

Parameter	Symbol	Value	Unit	
Power Dissipation	P_{D}	95	mW	
Peak Forward Current *1	I_{FP}	100	mA	
Forward Current	I_{F}	25	mA DC	
Reverse Voltage	V_R	5	V DC	
Operating Temperature	$T_{ m opr}$	-40 ~ +85	°C	
Storage Temperature	$T_{ m stg}$	-40 ~ +100	°C	
Soldering Temperature	$T_{\rm sol}$	260°C for 5 sec 3 times		

 $^{\,}$ $\!\!$ $\!\!$ $\!\!$ $\!\!$ 1 Condition for IFP is pulse of 1/10 duty and 0.1msec width.

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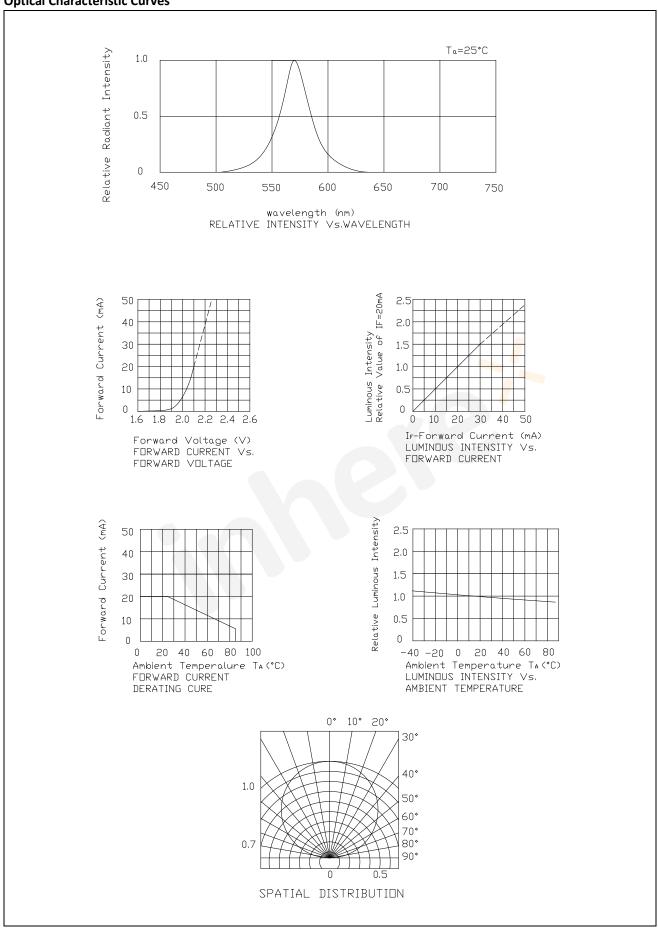
Date: 2018-08-13 Approved by: Wangxiaojun **Reliability Testing Conditions**

Classification	Test Item	Reference Standard	Test Conditions	Result
Endurance Test	Operation Life	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS-C-7021:B-1	Ta: Under room temperature Test time:1,000hrs IF= Product Recommended IF	0/32
	High Temperature High Humidity Storage	MIL-STD-202F:103B JIS-C-7021:B-11	Ta:85±5°C RH:90%-95% Test time:240hrs	0/32
	High Temperature Storage	MIL-STD-883:1008 JIS-C-7021:B-10	Ta:100±5℃ Test time:1,000hrs	0/32
	Low Temperature Storage	JIS-C-7021:B-11	Ta:-40±5℃ Test time:1,000hrs	0/32
Environmental Test	Temperature Cycling	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS-C-7021:A-2	Ta: -40 $^{\circ}$ C \pm 5 $^{\circ}$ C \sim 25 $^{\circ}$ C \pm 5 $^{\circ}$ C \sim 100 $^{\circ}$ C \pm 5 $^{\circ}$ C \sim 25 $^{\circ}$ C \pm 5 $^{\circ}$ C \rightarrow 30min 5min 30min 5min	0/32
	Thermal Chock	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(95) MIL-STD-883D:1011(1991)	Ta: -40 $^{\circ}$ \pm 5 $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ $^{\circ}$ 10min 10min Time:20min/cycle 10cycle	0/32
	Wetting balance	MIL-STD-883:2003 MIL-STD-202F:208D MIL-STD-883D:2003	Ta: 230℃±5℃ Time:5±0.5s	0/32
	Solder Resistance	MIL-STD-202F:210A MIL-STD-883D:1011 JIS-C-7021:A-1	Ta: 260 °C ± 10 °C Time:10 ± 1s	0/32

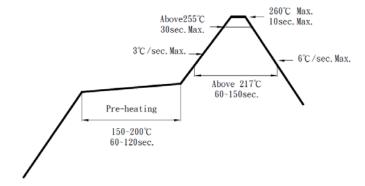
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Optical Characteristic Curves



IR-Reflow Soldering



- 1. Avoid any external stress applied to the resin while the LEDs are at high temperature, especially during soldering.
- 2. Avoid rapid cooling or any excess vibration during temperature ramp-down process
- 3. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

IRON Soldering

350℃ Within 3 sec., One time only.

Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the Inhere LEDs within the rated figures. Also, caution should be taken not to overload Inhere LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be

Storage:

In order to avoid the absorption of moisture, it is recommended to solder Inhere LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

designed so as be subjected to reverse voltage when turning off the Inhere LEDs.

- (1) Temperature: 5°C-30°C; Humidity: RH 60%Max.
- (2) After this bag is opened, devices that will be applied to infrared refold, vapor-phase refold, or equivalent soldering process must be:
- a. Completed within 168 hours.
- b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if:
- (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions:
- 48 hours at 60°C±3°C.

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